

The undisputed leader in interconnect systems for harsh environment applications

Amphenol®



Server Power

Company Introduction

Manufacturing connectors since 1932, we take pride that Amphenol Industrial Global Operations (AIGO) is the undisputed leader in interconnect systems for harsh environment applications. Such applications require a high degree of engineering sophistication and precision manufacturing capability. Innovations such as our RADSOK™ contact technology can supply gains of up to 50% in current carrying capability through the same size pin vs traditional contact designs. Connectors utilizing the RADSOK technology outperform conventional power interconnect products and are a better choice for the high current needs demanded by sophisticated electronics.

AIGO's product lines consist of rectangular, standard, miniature, fiber optic, EMI/EMP filter and a variety of special application connectors. Additionally, we manufacture value-add flex circuit and cable assemblies.

Our global manufacturing facilities include locations in Sidney, NY, Fraser, MI, Midland, TX, Shenzhen and Zhuhai, China, Winnipeg, Canada, and Nogales, Mexico. Our Sidney, NY facility is both ISO9001 certified and qualified to MIL-STD-790 requirements.

The Server Environment

Modern servers are capable of millions of transactions per second. They consume significant amounts of power, and produce tremendous amounts of heat while conducting the high amperage to manage these transactions.

Excessive heat can cause malfunctions and irreversible damage to servers while being expensive to manage. Therefore, minimizing temperature rise is a key concern when designing power systems for data centers.

AIGO has industry leading experience engineering high current and high density interconnect solutions. Our RADSOK technology and our proven engineering experience for harsh environments enable Amphenol Industrial Global Operations to develop optimal solutions for server power interconnect needs.



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RADSOK® Technology Advantages

RADSOK'S twisted grid configuration allows for 50% more current to pass through the same size pin, while providing increased reliability, ampacity and cycle durability as well as lower insertion force, T-rise and voltage drop.

HIGH RELIABILITY

Unique RADSOK® design and construction technology create an electrical contact interface that exceeds typical interconnect requirements. Applications in aerospace, medical, industrial, automotive, mining, offshore, and other harsh environments depend on high reliability of the Amphenol RADSOK® technology.

• LOW CONTACT ENGAGEMENT/SEPARATION FORCES

The hyperbolic lamella socket contact construction distributes normal forces over a high percentage of the mating pin surface. This creates a smooth, even engagement effort. This force distribution also contributes to excellent performance in vibration applications with resistance to typical fretting corrosion.

• LOW CONTACT RESISTANCE

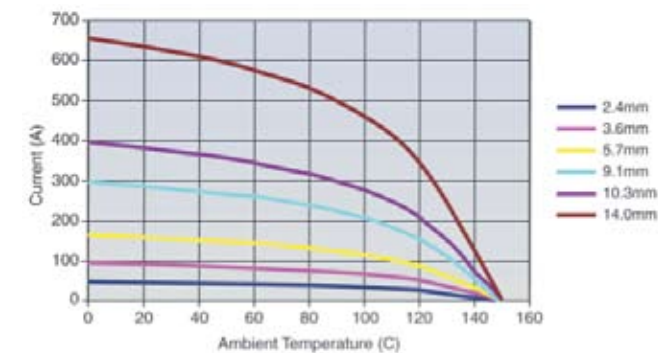
The large interface area between the socket lamella and pin surface result in very low contact resistance, enabling the RADSOK® contacts' high current ratings compared to traditional power contact designs.

• HIGH MATING CYCLE DURABILITY

RADSOK® contacts with typical silver plating finishes have demonstrated survival of 20,000 mating cycles. Specialized plating and contact lubricants can extend cycle life to 200,000 matings or higher. Even with continuous exposure to harsh environmental abuse (salt, sand, and high humidity), RADSOK® contacts have been tested to maintain low contact resistance beyond 10,000 mating cycles.

RADSOK® Derating Chart – Temperature vs. Current

Based on single conductors in free air. Wire cross-section same size as pin contact cross-sectional area.



RADSOK® Power to Board Connectors

High speed and high density electronics have driven demand for significant increases in the amount of power needed for power to board applications. To meet the need for higher current density interconnect Amphenol Industrial Global Operations developed the RADSOK® Power to Board series of connectors. RADSOK® Power to Board solutions facilitate the distribution of power with higher amperage, while allowing the design engineer to achieve size and weight reductions.

Conventional interconnects are limited in their ability to deliver high current with out consuming excessive board surface area. The RADSOK® Power to Board



RADSERT™'s compact footprint design can deliver up to 70A of current to the board. The high current density and small surface area connection provides flexibility of board design. RADSERT™ contacts are available in either press-fit or solder termination.

RADSOK® PCB RADSERT™

- High power to board interconnect in a small package
- Hyperbolic socket design ensures many points of contact
- Solder version or pre-loaded RADSERTS are installed during board fabrication
- 2.4mm RADSERT carries up to 35 Amps
- 3.6mm RADSERT carries up to 70 Amps
- Board thicknesses of .250" +/- .025"
- No special crimp tools required
- No threaded fasteners
- Eliminates risk of PTH cracking or delamination in board
- Faster through-put
- RoHs compliant

Part Number	Size	Amps	Termination
C10-642495-241	2.4mm	35	Solder
C10-700303-241	2.4mm R4	35	Solder
C10-639772-001	2.4mm	35	Press Fit
C10-700811-001	2.4mm R4	35	Press Fit
C10-665213-001	3.6mm	70	Solder
C10-700812-001	3.6mm R4	70	Solder
C10-665222-000	3.6mm	70	Press Fit
C10-700814-000	3.6mm R4	70	Press Fit



The RADSOK® PGY™ provides a compact and robust right angle power to board interconnect. Designed to mate with either a 3.6mm or 5.7mm pin, The RADSOK® PGY™ can bring up to 120A to the board. The radial design of the RADSOK® contact gives you more contact surface area lowering temperature rise and reducing potential heat related failures.

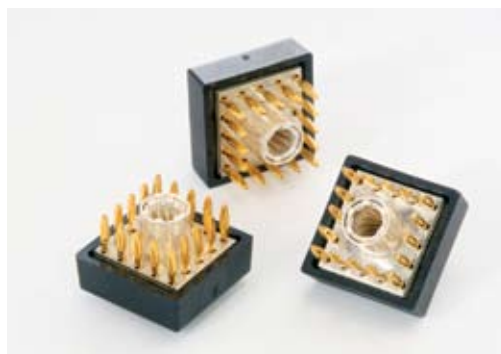
RADSOK® PCB PGY™

- Orthogonal connection between card edge and busbar/backplane
- Compact footprint
- Legs of the PGY dissipate high power evenly
- 5.7mm carries up to 120 Amps
- 3.6mm carries up to 70 Amps
- No threaded fasteners
- No special crimp tools required
- RADSOK's highest power to board level product
- Faster through-put
- RoHs compliant

Part Number	Size	Amps
C10-639801-000	3.6mm	70
C10-700259-000	3.6mm R4 long	70
C10-700298-000	3.7mm R4	70
C10-639800-001	5.7mm	120
C10-700261-000	5.7mm R4	120

series of connectors incorporates a hyperbolic lamella socket contact construction that provides more contact surface area. The high performance contact enables higher current carrying capabilities with lower temperature rises than traditional contact systems.

Amphenol RADSOK® Power to Board product line offers many options for delivering high current, single-point connections to the PCB. Please contact your Amphenol Industrial representative for product extensions and custom applications.



The RADSOK® Powerblok™'s compact footprint ½" x ½" can supply up to 70A to backplane power connections. Current is distributed over 16 compliant pins. The Powerblok™ is available for top or bottom entry and offered with a touch-proof cover.

RADSOK® PCB PowerBlok™

- High power to board interconnect in a small package
- Compact footprint 0.618" x 0.618"
- 3.0mm RADSOK® carries up to 70 amperes
- Backplane power interface with compliant pins for signals
- Touchproof cover
- Radial design ensures many points of contact
- Reduces failure modes, eliminates burn outs
- No threaded fasteners
- No special crimp tools required
- Eliminates possible stress fractures in board
- Faster through-put
- RoHs compliant

Part Number	Size	Amps
C10-639323-000	3.0mm	70
C10-700300-001	3.0mm R4	70
C10-700294-001	3.0mm	60

SURLOK™

- High current rating, high ampacity in a smaller package
- High reliability; meets or exceeds the electrical performance of bolt-on compression lugs
- Easy field install - crimp with standard color-coded dies (Udie and 4 indenter). No torque wrenches required.



- Integral locking feature plus locking cap
- RADSOK technology boosts the ampacity by 50% or more compared to mil-spec contacts. RADSOK contacts provide the advantages of low insertion force and high cycle durability.
- RoHS compliant

Wire Size	RADSOK Size	Current Rating	SurLok Assembly Part Number	Lug Only Part Number	Conductor Max. Dia.	Crimp Code
8 AWG	3.6mm	70 Amps	PSL-368K	PSL-368	0.17 in.	Red 21
6 AWG	5.7mm	100 Amps	PSL-576K	PSL-576	0.21 in.	Blue 24
4 AWG	5.7mm	125 Amps	PSL-574K	PSL-574	0.27 in.	Gray 29
2 AWG	8.0mm	175 Amps	PSL-802K	PSL-802	0.30 in.	Brown 33
1 AWG	8.0mm	200 Amps	PSL-801K	PSL-801	0.35 in.	Green 37
1/0 AWG	10.3mm	250 Amps	PSL-1031K	PSL-10310	0.38 in.	Pink 42
2/0 AWG	10.3mm	300 Amps	PSL-10320K	PSL-10320	0.44 in.	Black 45

Pin Dia.	Max. Current	Part Number	Thread (male)
3.6mm	70 Amps	PSLP-36	M3x0.5
5.7mm	125 Amps	PSLP-57	MSx0.8
8.0mm	200 Amps	PSLP-80	M8x1.25
10.3mm	300 Amps	PSLP-103	M10x1.5

Notes: (1) Surlok™ Assembly contains the wire crimp lug, plus a two-piece dielectric clamshell housing. Housing is available in black color as standard. Consult Amphenol Industrial for alternate color (2) Lug only specifies the wire crimp RADSOK SurLok lug, less the plastic housings.

AMPHE-GTR

- Utilizes RADSOK® high amperage socket contact technology, enabling increased current ratings to 120A on individual contacts.
- Currently available in shell size 32 with 4 conductors or 5 conductors.
- Current style is straight plug that houses the RADSOK® sockets and a box mount receptacle with pin contacts.
- Compression (setscrew) wire termination to the 4/6AWG or 8/10AWG conductors allows easy field replacement of pin or socket contacts, or complete plug and receptacle assemblies, without requiring specialized tooling.
- Meets same performance levels as GT Series.
- Listed to UL/CUL 1977/1682/817 Standard, control number 19VP.



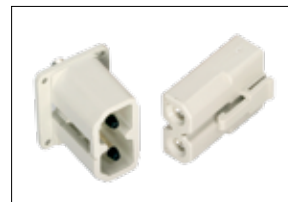
- Utilizes a standard PG adapter watertight strain relief on the plug to achieve IP67 seal rating.
- Flammability rated to UL94V-0.

AMPHE-GTR PLUG		AMPHE-GTR RECEPTACLE	
GTR Plug in Shell Size 32 with 4 Conductors		GTR Receptacle in Shell Size 32 with 4 Conductors	
4 Conductors			
AIO Part Number	Description	Wire Range	Rated Current
GT06PCM32-ARS-30(29R)	Plug	8-10 AWG	30 Amps (cont.)
GT06PCM32-ARS-40(29R)	Plug	8-10 AWG	40 Amps (cont.)
GT06PCM32-ARS-50(29R)	Plug	4-6 AWG	50 Amps (cont.)
GT06PCM32-ARS-70(29OS)	Plug	4-6 AWG	70 Amps (cont.)
GT06PCM32-ARS-120(36OS)	Plug	4 AWG	120 Amps (cont.)
GT030PCM32-ARP-80	Receptacle	4-6 AWG	80 Amps (cont.)
GT030PCM32-ARP-120	Receptacle	4 AWG	120 Amps (cont.)
5 Conductors			
AIO Part Number	Description	Wire Range	Cable Range
10-610142-001	Plug	8-10 AWG	.472 - .787
10-610142-002	Plug	8-10 AWG	.708 - .984
10-610142-003	Plug	4-6 AWG	.472 - .787
10-610142-004	Plug	4-6 AWG	.708 - .984
10-610147-001	Receptacle	8-10 AWG	N/A
10-610147-002	Receptacle	4-6 AWG	N/A
10-610222-001	FBLM Receptacle	8-10 AWG	N/A
10-610222-002	FBLM Receptacle	4-6 AWG	N/A

For complete dimensional information on Amphe-GTR Series see Product Data Sheet #190. Also refer to Amphenol GT Series catalog 12-024.

AMPHE-PD

Technical Specifications: 3.6mm is UL rated 69 amps (6 AWG). CSA rated 55 Amps (6 AWG). 5.7mm (non-UL) is rated for 120 amps. Molded from UL94V-0 thermoplastic (self extinguishing). Meets RoHS and UL-94V-0 guidelines. 2-pole DC Power interconnect in about 1 square inch (3.6mm version) and 1.75 inch square (5.7mm version). Passes UL and TUV finger proof design standards.



Additional benefits of the Amphe-PD™ product include:

- Low cost, 100% molded housings
- Integrated latching mechanism
- Easy, Tool-less assembly
- Low Insertion Force
- High Reliability
- High Cycle Durability
- High Ampacity
- Tactile and audible locking
- Proven metal clip contact retention on receptacles
- TPA device on plug to insure socket locking



The Future of RADSOK® R4 Technology

The R4 version of the RADSOK® represents the culmination of three years of research and development in laser welding copper based alloys. This innovative approach to construction of the RADSOK® cartridge provides benefits previously unavailable in the product line.

- Packaging restraints are reduced due to a smaller outside diameter of the component
- Automated assembly processes result in less manufacturing variability
- Better consistency in performance
- Better mechanical strength in a welded assembly
- Lower voltage drop/resistance
- Low temperature rise